SLOS454-JANUARY 2005

## WIDEBAND, LOW NOISE, LOW DISTORTION FULLY DIFFERENTIAL AMPLIFIER

#### **FEATURES**

- **Fully Differential Architecture**
- **Centered Input Common-mode Range**
- Minimum Gain of 2V/V (6 dB)
- Bandwidth: 1900 MHz (100 mVpp, G = 10 dB,  $R_1 = 200 \Omega$
- Slew Rate:  $6600 \text{ V/}\mu\text{s}$  (2V step, G = 10 dB)
- 1% Settling Time: 2 ns (2 V step, G = 10 dB)
- HD<sub>2</sub>: -75 dBc at 100 MHz (2 Vpp, G = 10 dB,  $R_1 = 1 k\Omega$
- $HD_3$ : -80 dBc at 100 MHz (2 Vpp, G = 10 dB,  $R_1 = 1 k\Omega$
- OIP<sub>2</sub>: 79 dBm at 70 MHz (2 Vpp envelope, G = 10 dB
- OIP<sub>3</sub>: 43 dBm at 70 MHz (2 Vpp envelope, G = 10 dB
- Input Voltage Noise: 1.9 nV/ $\sqrt{\text{Hz}}$  (f >10 MHz)
- Noise Figure: 17.1 dB (50  $\Omega$  System, G = 10
- **Output Common-Mode Control**
- **Power Supply:** 
  - Voltage: 3 V (±1.5 V) to 5 V (±2.5 V)
  - Current: 37.7 mA
- Power-Down Capability: 0.65 mA

#### **APPLICATIONS**

- 5 V Data Acquisition Systems High **Linearity ADC Amplifier**
- **Wireless Communication**
- **Medical Imaging**
- **Test and Measurement**

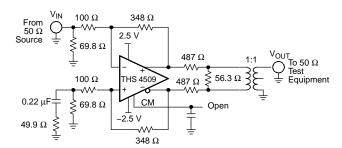
#### **DESCRIPTION**

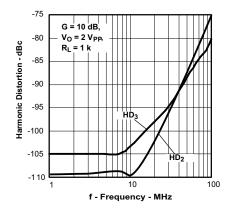
The THS4509 is a wideband, fully differential op amp designed for 5 V data acquisition systems. It has very low noise at 1.9 nV/\(\sqrt{Hz}\), and extremely low harmonic distortion of -75 dBc HD2 and -80 dBc HD3 at 100 MHz with 2 Vpp, G = 10 dB, and 1 k $\Omega$  load. Slew rate is very high at 6600 Vus and with settling time of 2 ns to 1% (2 V step) it is ideal for pulsed applications. It is designed for minimum gain of 6 dB, but is optimized for gain of 10 dB.

To allow for dc coupling to ADCs, its unique output common-mode control circuit maintains the output common-mode voltage within 3 mV offset (typ) from the set voltage, when set within 0.5 V of mid-supply, with less than 4 mV differential offset voltage. The common-mode set point is set to mid-supply by internal circuitry, which may be over-driven from an external source.

The input and output are optimized for best performance with their common-mode voltages set to mid-supply. Along with high performance at low power supply voltage, this makes for extremely high performance single supply 5 V data acquisition systems. The combined performance of the THS4509 in a gain of 10 dB driving the ADS5500 ADC, sampling at 125 MSPS, is 81 dBc SFDR and 69.1 dBc SNR with a -1 dBFS signal at 70 MHz.

The THS4509 is offered in a Quad 16-pin leadless QFN package (RGT), and is characterized for operation over the full industrial temperature range from -40°C to 85°C.







Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.





This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### PACKAGING/ORDERING INFORMATION

	PACKAGED DEVICES	
TEMPERATURE	QUAD QFN <sup>(1)(2)</sup> (RGT-16)	SYMBOL
–40°C to 85°C	THS4509RGTT	
-40°C 10 65°C	THS4509RGTR	_

<sup>(1)</sup> This package is available taped and reeled. The R suffix standard quantity is 3000. The T suffix standard quantity is 250.

#### **ABSOLUTE MAXIMUM RATINGS**

over operating free-air temperature range (unless otherwise noted)

			UNIT
V <sub>S</sub> - to V <sub>S+</sub>	Supply voltage		6 V
V <sub>I</sub>	Input voltage		±VS
V <sub>ID</sub>	Differential input	t voltage	4 V
Io	Output current <sup>(1)</sup>		200 mA
	Continuous pow	rer dissipation	See Dissipation Rating Table
T <sub>J</sub>	Maximum junction temperature		150°C
T <sub>A</sub>	Operating free-air temperature range		−40°C to 85°C
T <sub>stg</sub>	Storage tempera	ature range	−65°C to 150°C
	Lead temperatur	re 1,6 mm (1/16 inch) from case for 10 seconds	300°C
		НВМ	2000
	ESD ratings	CDM	1500
		MM	100

<sup>(1)</sup> The THS4509 incorporates a (QFN) exposed thermal pad on the underside of the chip. This acts as a heatsink and must be connected to a thermally dissipative plane for proper power dissipation. Failure to do so may result in exceeding the maximum junction temperature which could permanently damage the device. See TI technical brief SLMA002 and SLMA004 for more information about utilizing the QFN thermally enhanced package.

#### DISSIPATION RATINGS TABLE PER PACKAGE

PACKAGE	CKAGE A		POWER RATING		
PACKAGE	A)C A)A	⊎JA	T <sub>A</sub> ≤ 25°C	T <sub>A</sub> = 85°C	
RGT (16)	2.4°C/W	39.5°C/W	2.3 W	225 mW	

<sup>2)</sup> The exposed thermal pad is electrically isolated from all other pins.



## SPECIFICATIONS; $V_{S+} - V_{S-} = 5 \text{ V}$ :

Test conditions unless otherwise noted:  $V_{S+}$  = +2.5 V,  $V_{S-}$  = -2.5 V, CM = open,  $V_{O}$  = 2 Vpp,  $R_{F}$  = 349  $\Omega$ ,  $R_{L}$  = 200  $\Omega$  Differential, G = 10 dB, Single-Ended Input, Differential Output, Input and Output Referenced to Mid-supply

			TYP		OVER	RTEMPER	ATURE	
PARAMETER	TEST CONDI	TIONS	25°C	25°C	–40°C to 85°C	UNITS	MIN/ MAX	TEST LEVEL <sup>(1)</sup>
AC PERFORMANCE								
	$G = 6 dB$ , $V_O = 100 mVpp$	)	2.0			GHz	Тур	
Small-Signal Bandwidth	$G = 10 \text{ dB}, V_0 = 100 \text{ mVp}$	ор	1.9			GHz	Тур	
Cinali Digital Daria Matti	$G = 14 \text{ dB}, V_0 = 100 \text{ mVp}$	op	600			MHz	Тур	
	$G = 20 \text{ dB}, V_0 = 100 \text{ mVp}$	ор	275			MHz	Тур	
Gain-Bandwidth Product	G = 20 dB		3			GHz	Тур	
Bandwidth for 0.1dB flatness	$G = 10 dB, V_O = 2 Vpp$		300			MHz	Тур	
Large-Signal Bandwidth	$G = 10 dB, V_O = 2 Vpp$		1.5			GHz	Тур	
Slew Rate (Differential)	2V Step		6600			V/µs	Тур	
Rise Time	2V Step		0.5			ns	Тур	
Fall Time	2V Step		0.5			ns	Тур	
Settling Time to 1%	V <sub>O</sub> = 2 V Step		2			ns	Тур	
Settling Time to 0.1%	V <sub>O</sub> = 2 V Step		10			ns	Тур	
and Onder Henry aris Distantian	f = 10 MHz		-104			dBc	Тур	
2 <sup>nd</sup> Order Harmonic Distortion (Single-ended input)	f = 50 MHz		-80			dBc	Тур	
. ,	f = 100 MHz		-68			dBc	Тур	
	f = 10 MHz	f = 10 MHz				dBc	Тур	С
3 <sup>rd</sup> Order Harmonic Distortion (Single-ended input)	f = 50 MHz		-92			dBc	Тур	
(9.0	f = 100 MHz		-81			dBc	Тур	
2 <sup>nd</sup> Order Intermodulation Distortion	$V_O = 2$ Vpp envelope, 200 kHz Tone Spacing, $R_L = 499 \Omega$	f <sub>C</sub> = 70 MHz	-78			dBc	Тур	
(Single-ended input)		f <sub>C</sub> = 140 MHz	-64			dBc	Тур	
3 <sup>rd</sup> Order Intermodulation Distortion		f <sub>C</sub> = 70 MHz	-95			dBc	Тур	
(Single-ended input)		f <sub>C</sub> = 140 MHz	-78			dBc	Тур	
2 <sup>nd</sup> Order Output Intercept Point		f <sub>C</sub> = 70 MHz	78			dBm	Тур	
(Single-ended input)	000 Id In Town Conneils	f <sub>C</sub> = 140 MHz	58			dBm	Тур	
3rd Order Output Intercept Point	200 kHz Tone Spacing	f <sub>C</sub> = 70 MHz	43			dBm	Тур	
(Single-ended input)		f <sub>C</sub> = 140 MHz	38			dBm	Тур	
4 ID 0 D : (2)	f <sub>C</sub> = 70 MHz		12.2			9	-	
1-dB Compression Point (2)	f <sub>C</sub> = 140 MHz		10.8			dBm	Тур	
Noise Figure	50 Ω System, 10 MHz		17.1			dB	Тур	
Input Voltage Noise	f > 10 MHz		1.9			nV/√ <del>Hz</del>	Тур	
Input Current Noise	f > 10 MHz		2.2			pA/√ <del>Hz</del>	Тур	
DC PERFORMANCE								
Open-Loop Voltage Gain (A <sub>OL</sub> )			68			dB	Тур	С
Input Offset Voltage			0.5	0.8	1	mV	Max	
Average Offset Voltage Drift					2.6	μV/°C	Тур	В
Input Bias Current			6	8	13	μA	Max	А
Average Bias Current Drift					20	nA/°C	Тур	В
Input Offset Current			1.6	3.6	4.5	μA	Max	Α
Average Offset Current Drift					4	nA/°C	Тур	В
INPUT			1		1	i		
Common-Mode Input Range High			1.75			V	Max	
					1			Α
Common-Mode Input Range Low			-1.75			V	Min	

<sup>(1)</sup> Test levels: (A) 100% tested at 25°C. Overtemperature limits by characterization and simulation. (B) Limits set by characterization and simulation. (C) Typical value only for information

simulation. (C) Typical value only for information.

(2) The 1-dB compression point is measured at the load with 50-Ω double termination. Add 3 dB to refer to amplifier output.



## SPECIFICATIONS; $V_{S+} - V_{S-} = 5 \text{ V: (continued)}$

Test conditions unless otherwise noted:  $V_{S+}$  = +2.5 V,  $V_{S-}$  = -2.5 V, CM = open,  $V_{O}$  = 2 Vpp,  $R_{F}$  = 349  $\Omega$ ,  $R_{L}$  = 200  $\Omega$  Differential, G = 10 dB, Single-Ended Input, Differential Output, Input and Output Referenced to Mid-supply

		TYP	OVER TEMPERATURE					
PARAMETER	TEST CONDITIONS 2		25°C	–40°C to 85°C	UNITS	MIN/ MAX	TEST LEVEL <sup>(1)</sup>	
OUTPUT		-						
Maximum Output Voltage High	Fach cutaut with 100 O to mid cumply	1.4	1.35	1.13	V	Min		
Minimum Output Voltage Low	Each output with 100 Ω to mid-supply	-1.4	-1.35	-1.13	٧	Max	Α	
Differential Output Voltage Swing		5.6	5.4	4.5	V	Min		
Differential Output Current Drive	R <sub>L</sub> = 10 Ω	96			mA	Тур		
Output Balance Error	V <sub>O</sub> = 100 mV, f = 1 MHz	-49			dB	Тур	С	
Closed-Loop Output Impedance	f = 1 MHz	0.3			Ω	Тур		
OUTPUT COMMON-MODE VOLTAGE CONT	ROL	-						
Small-Signal Bandwidth		700			MHz	Тур		
Slew Rate		110			V/µs	Тур		
Gain		1			V/V	Тур		
Output Common-Mode Offset from CM input	-1 V < CM < 1 V	5			mV	Тур		
CM Input Bias Current	-1 V < CM < 1 V	±40			μΑ	Тур	С	
CM Input Voltage Range		-1.5 to 1.5			V	Тур		
CM Input Impedance		23    1			kΩ ∥ pF	Тур		
CM Default Voltage		0			V	Тур		
POWER SUPPLY		•						
Specified Operating Voltage		5	5.5	5.5	V	Max	С	
Maximum Quiescent Current		37.7	38.6	38.7	mA	Max	Δ.	
Minimum Quiescent Current		37.7	36.4	36	mA	Min	Α	
Power Supply Rejection (±PSRR)		90			dB	Min	С	
POWERDOWN								
Enable Voltage Threshold	Referenced to V <sub>s-</sub> , Device Assured <i>on</i> above 2.1 V	1.6			V	Min	0	
Disable Voltage Threshold	Referenced to V <sub>s-</sub> , Device Assured <i>off</i> below 0.7 V	1.6			V	Max	С	
Powerdown Quiescent Current		0.65	0.76	0.89	mA	Max	Α	
Input Bias Current	PD = V <sub>S-</sub>	100			μA	Тур		
Input Impedance		50    2			kΩ ∥ pF	Тур	0	
Turn-on Time Delay	Measured to output on	55			ns	Тур	С	
Turn-off Time Delay	Measured to output off	10			μs	Тур		



## SPECIFICATIONS; $V_{S+} - V_{S-} = 3 \text{ V}$ :

Test conditions unless otherwise noted:  $V_{S+}$  = +1.5 V,  $V_{S-}$  = -1.5 V, CM = open,  $V_{O}$  = 1 Vpp,  $R_{F}$  = 349  $\Omega$ ,  $R_{L}$  = 200  $\Omega$  Differential, G = 10 dB, Single-Ended Input, Differential Output, Input and Output Referenced to Mid-supply

			TYP		OVER	RTEMPERA	TURE		
PARAMETER	TEST CONDITIONS		25°C	25°C	–40°C to 85°C	UNITS	MIN/ MAX	TEST LEVEL(1)	
AC PERFORMANCE									
	$G = 6 dB$ , $V_O = 100 mVp$	р	1.9			GHz	Тур		
Small-Signal Bandwidth	$G = 10 dB, V_0 = 100 mV$	рр	1.6			GHz	Тур		
Small-Signal Bandwidth	$G = 14 dB, V_O = 100 mV$	рр	625			MHz	Тур		
	$G = 20 \text{ dB}, V_0 = 100 \text{ mV}$	рр	260			MHz	Тур		
Gain-Bandwidth Product	G = 20 dB		3			GHz	Тур		
Bandwidth for 0.1dB flatness	$G = 10 dB, V_O = 1 Vpp$		400			MHz	Тур		
Large-Signal Bandwidth	$G = 10 dB, V_O = 1 Vpp$		1.5			GHz	Тур		
Slew Rate (Differential)	1V Step		3500			V/µs	Тур		
Rise Time	1V Step		0.25			ns	Тур		
Fall Time	1V Step		0.25			ns	Тур		
Settling Time to 1%	V <sub>O</sub> = 1 V Step		1			ns	Тур		
	f = 10 MHz		-107			dBc	Тур		
2 <sup>nd</sup> Order Harmonic Distortion (Single-ended input)	f = 50 MHz		-83			dBc	Тур		
(Olligie Chaca input)	f = 100 MHz		-60			dBc	Тур		
	f = 10 MHz		-87			dBc	Тур		
3 <sup>rd</sup> Order Harmonic Distortion (Single-ended input)	f = 50 MHz		-65			dBc	Тур	С	
(Girigio crided iripat)	f = 100 MHz		-54			dBc	Тур		
2 <sup>nd</sup> Order Intermodulation Distortion		f <sub>C</sub> = 70 MHz	-77			dBc	Тур		
(Single-ended input)	$V_O$ = 1 Vpp envelope, 200 kHz Tone Spacing, $R_L$ = 200 Ω	f <sub>C</sub> = 140 MHz	-54			dBc	Тур		
3 <sup>rd</sup> Order Intermodulation Distortion		f <sub>C</sub> = 70 MHz	-77			dBc	Тур		
(Single-ended input)		f <sub>C</sub> = 140 MHz	-62			dBc	Тур		
2 <sup>nd</sup> Order Output Intercept Point		f <sub>C</sub> = 70 MHz	72			dBm	Тур		
(Single-ended input)	000111 T 0	f <sub>C</sub> = 140 MHz	52			dBm	Тур		
3rd Order Output Intercept Point	200 kHz Tone Spacing	f <sub>C</sub> = 70 MHz	38.5			dBm	Тур		
(Single-ended input)		f <sub>C</sub> = 140 MHz	30			dBm	Тур		
4 dD Common Delint/2\	f <sub>c</sub> = 70 MHz		2.2				т		
1-dB Compression Point <sup>(2)</sup>	f <sub>c</sub> = 140 MHz		0.25			dBm	Тур		
Noise Figure	50 Ω System, 10 MHz		17.1			dB	Тур		
Input Voltage Noise	f > 10 MHz		1.9			nV/√ <del>Hz</del>	Тур		
Input Current Noise	f > 10 MHz		2.2			pA/√ <del>Hz</del>	Тур		
DC PERFORMANCE									
Open-Loop Voltage Gain (A <sub>OL</sub> )			68			dB	Тур	С	
Input Offset Voltage			0.5	0.8	1	mV	Max		
Average Offset Voltage Drift					2.6	μV/°C	Тур	В	
Input Bias Current			6	8	13	μA	Max	Α	
Average Bias Current Drift					20	nA/°C	Тур	В	
Input Offset Current			1.6	3.6	4.5	μA	Max	Α	
Average Offset Current Drift					4	nA/°C	Тур	В	
INPUT	1		1		1		1	I.	
Common-Mode Input Range High			0.75			V	Max		
Common-Mode Input Range Low			-0.75			V	Min	Α	
Common-Mode Rejection Ratio			80			dB	Min	В	

<sup>(1)</sup> Test levels: (A) 100% tested at 25°C. Overtemperature limits by characterization and simulation. (B) Limits set by characterization and simulation. (C) Typical value only for information.

<sup>(2)</sup> The 1-dB compression point is measured at the load with 50-Ω double termination. Add 3 dB to refer to amplifier output.



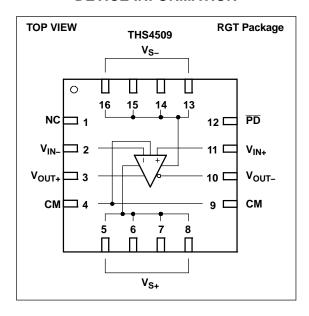
## SPECIFICATIONS; $V_{S+}-V_{S-}=3$ V: (continued)

Test conditions unless otherwise noted:  $V_{S+}$  = +1.5 V,  $V_{S-}$  = -1.5 V, CM = open,  $V_{O}$  = 1 Vpp,  $R_{F}$  = 349  $\Omega$ ,  $R_{L}$  = 200  $\Omega$  Differential, G = 10 dB, Single-Ended Input, Differential Output, Input and Output Referenced to Mid-supply

		TYP	P OVER TEMPERATURE					
PARAMETER	TEST CONDITIONS	25°C	25°C	–40°C to 85°C	UNITS	MIN/ MAX	TEST LEVEL(1)	
ОИТРИТ			•			•	•	
Maximum Output Voltage High	Fach output with 1000 to mid output	0.45	0.43	0.2	V	Min		
Minimum Output Voltage Low	Each output with 100Ω to mid-supply	-0.45	-0.43	-0.2	V	Max	Α	
Differential Output Voltage Swing		1.8	1.65	0.8	V	Min		
Differential Output Current Drive	R <sub>L</sub> = 20 Ω	20	18	18	mA	Min		
Output Balance Error	V <sub>O</sub> = 100 mV, f = 1 MHz	-49			dB	Тур	С	
Closed-Loop Output Impedance	f = 1 MHz	0.3			Ω	Тур		
OUTPUT COMMON-MODE VOLTAGE CONT	ROL							
Small-Signal Bandwidth		570			MHz	Тур		
Slew Rate		60			V/µs	Тур		
Gain		1			V/V	Тур		
Output Common-Mode Offset from CM input	-0.5 V < CM < 0.5 V	4			mV	Тур		
CM Input Bias Current	-0.5 V < CM < 0.5 V	±40			μA	Тур	С	
CM Input Voltage Range		-1.5 to 1.5			V	Тур		
CM Input Impedance		20    1			kΩ∥ pF	Тур		
CM Default Voltage		0			V	Тур		
POWER SUPPLY								
Specified Operating Voltage		3	5.5	5.5	V	Max		
Maximum Quiescent Current		34.8	35.8	36	mA	Max	Α	
Minimum Quiescent Current		34.8	33.8	33	mA	Min		
Power Supply Rejection (±PSRR)		78			dB	Min	С	
POWERDOWN						•	•	
Enable Voltage Threshold	Referenced to V <sub>s</sub> _ Device Assured <i>on</i> above 2.1 V				V	Min	0	
Disable Voltage Threshold	Referenced to V <sub>s</sub> _ Device Assured <i>off</i> below 0.7 V				٧	Max	C	
Powerdown Quiescent Current		0.46	0.53	0.67	mA	Max	Α	
Input Bias Current	PD = V <sub>S-</sub>	65			μA	Тур		
Input Impedance		50    2			kΩ∥ pF	Тур		
Turn-on Time Delay	Measured to output on	100			ns	Тур	С	
Turn-off Time Delay	Measured to output off	10			μs	Тур		



#### **DEVICE INFORMATION**



#### **TERMINAL FUNCTIONS**

TERMINAL (RGT PACKAGE)		DESCRIPTION
NO.	NAME	
1	NC	No internal connection
2	V <sub>IN</sub>	Inverting amplifier input
3	V <sub>OUT+</sub>	Non-inverted amplifier output
4,9	СМ	Common-mode voltage input
5,6,7,8	$V_{S+}$	Positive amplifier power supply input
10	$V_{OUT-}$	Inverted amplifier output
11	V <sub>IN+</sub>	Non-inverting amplifier input
12	PD	Powerdown, $\overline{PD}$ = logic low puts part into low power mode, $\overline{PD}$ = logic high or open for normal operation
13,14,15,16	V <sub>S-</sub>	Negative amplifier power supply input



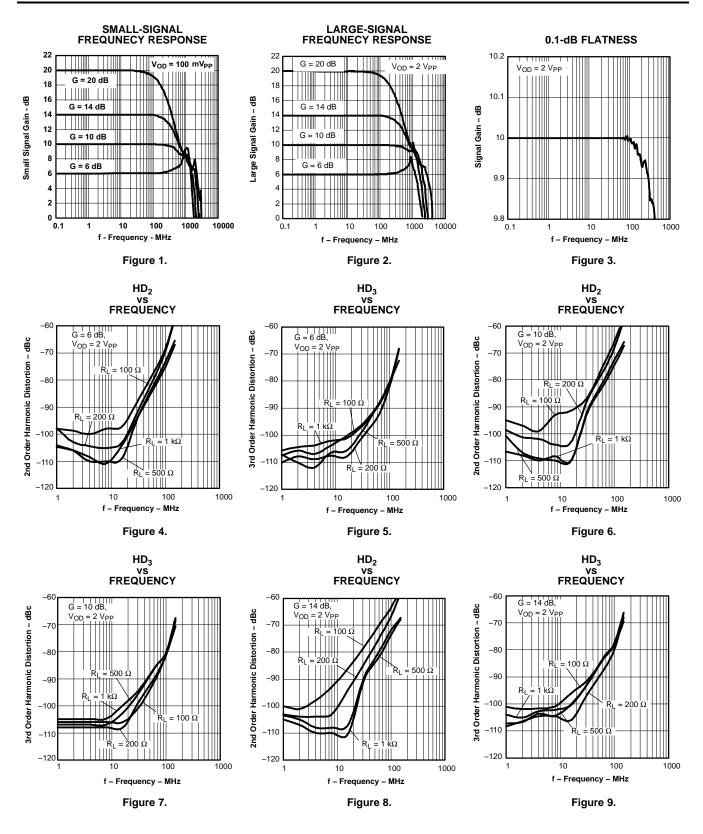
#### **TYPICAL CHARACTERISTICS**

## TYPICAL AC PERFORMANCE: $V_{S+} - V_{S-} = 5 \text{ V}$

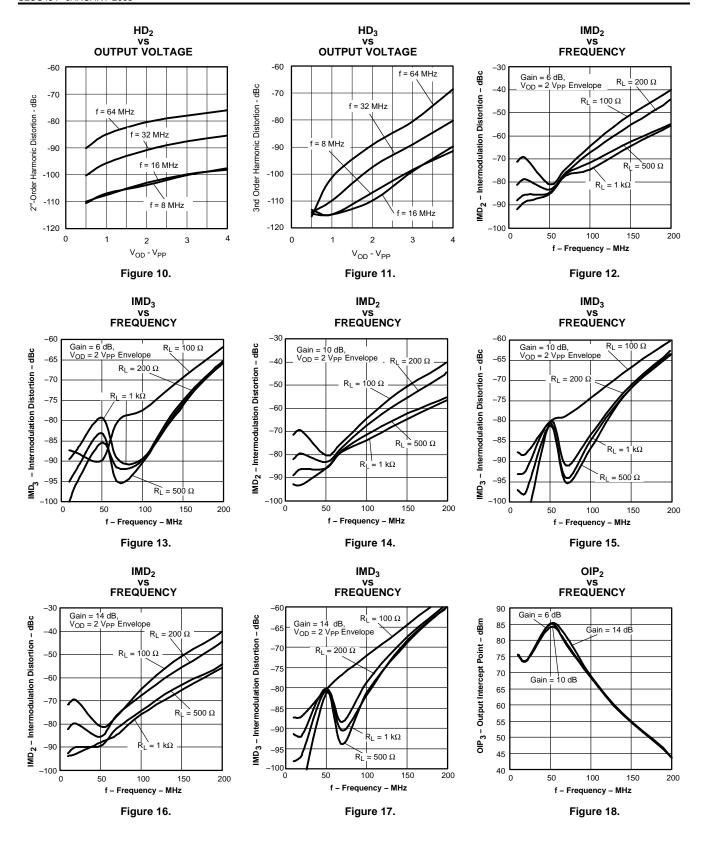
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Small-Signal Frequnecy Res	ponse		Figure 1
Large Signal Frequnecy Res	sponse		Figure 2
0.1 dB Flatness			Figure 3
	$HD_2$ , $G = 6 dB$ , $V_{OD} = 2 V_{PP}$	vs Frequency	Figure 4
	$HD_3$ , $G = 6 dB$ , $V_{OD} = 2 V_{PP}$	vs Frequency	Figure 5
	$HD_2$ , $G = 10$ dB, $V_{OD} = 2$ $V_{PP}$	vs Frequency	Figure 6
Harmonic	$HD_3$ , $G = 10$ dB, $V_{OD} = 2$ $V_{PP}$	vs Frequency	Figure 7
Distortion	$HD_2$ , $G = 14$ dB, $V_{OD} = 2$ $V_{PP}$	vs Frequency	Figure 8
	$HD_3$ , $G = 14$ dB, $V_{OD} = 2$ $V_{PP}$	vs Frequency	Figure 9
	$HD_2$ , $G = 10 dB$	vs Output voltage	Figure 10
	$HD_3$ , $G = 10 dB$	vs Output voltage	Figure 11
	$IMD_2$ , G = 6 dB, $V_{OD}$ = 2 $V_{PP}$	vs Frequency	Figure 12
	$IMD_3$ , G = 6 dB, $V_{OD}$ = 2 $V_{PP}$	vs Frequency	Figure 13
Intermodulation	$IMD_2$ , G = 10 dB, $V_{OD}$ = 2 $V_{PP}$	vs Frequency	Figure 14
Distortion	$IMD_3$ , $G = 10 dB$ , $V_{OD} = 2 V_{PP}$	vs Frequency	Figure 15
	$IMD_2$ , G = 14 dB, $V_{OD}$ = 2 $V_{PP}$	vs Frequency	Figure 16
	$IMD_3$ , G = 14 dB, $V_{OD}$ = 2 $V_{PP}$	vs Frequency	Figure 17
Output Intercent Daint	OIP <sub>2</sub>	vs Frequency	Figure 18
Output Intercept Point	OIP <sub>3</sub>	vs Frequency	Figure 19
S-Parameters		vs Frequency	Figure 20
Slew Rate		vs Output Voltage	Figure 21
Transient Response			Figure 22
Settling Time			Figure 23
Rejection Ratio		vs Frequency	Figure 24
Output Impedance		vs Frequency	Figure 25
Overdrive Recovery			Figure 26
Output Voltage Swing		vs Load Resistance	Figure 27
Turn-Off Time			Figure 28
Turn-On Time			Figure 29
Input Offset Voltage		vs Input Common-Mode Voltage	Figure 30
Open Loop Gain		vs Frequency	Figure 31
Input Referred Noise		vs Frequency	Figure 32
Noise Figure		vs Frequency	Figure 33
Quiescent Current		vs Supply Voltage	Figure 34
Power Supply Current		vs Supply Voltage in Powerdown Mode	Figure 35
Output Balance Error		vs Frequency	Figure 36
CM Input Impedence		vs Frequency	Figure 37
CM Small-Signal Frequency	Response		Figure 38
CM Input Bias Current		vs CM Input Voltage	Figure 39
Differential Output Offset Vol	Itage	vs CM Input Voltage	Figure 40
Output Common-Mode Offse	et	vs CM Input Voltage	Figure 41

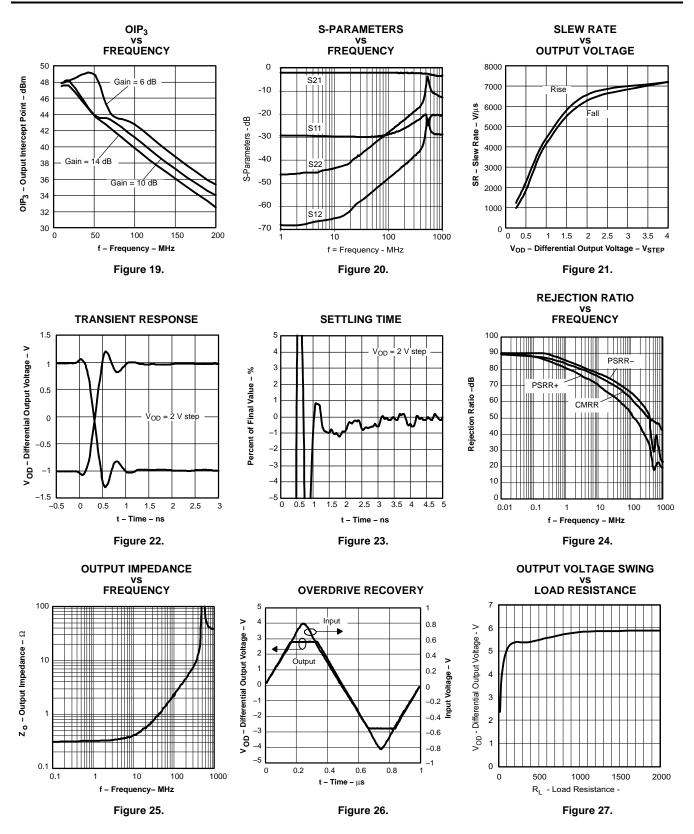




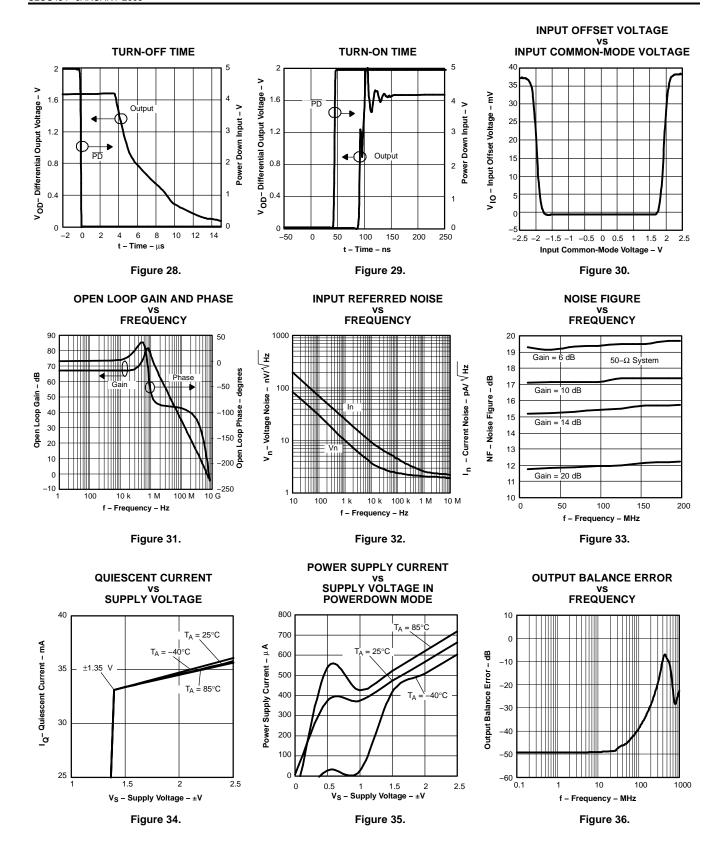














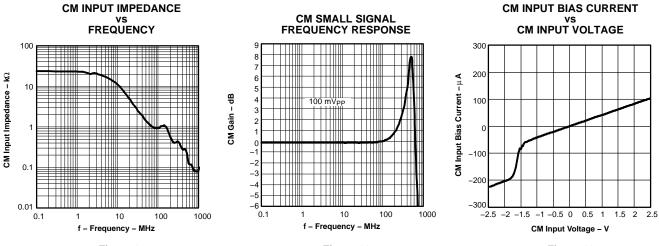
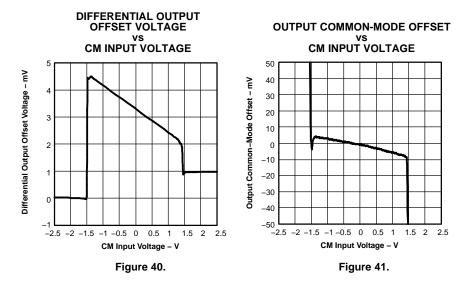


Figure 37. Figure 38. Figure 39.



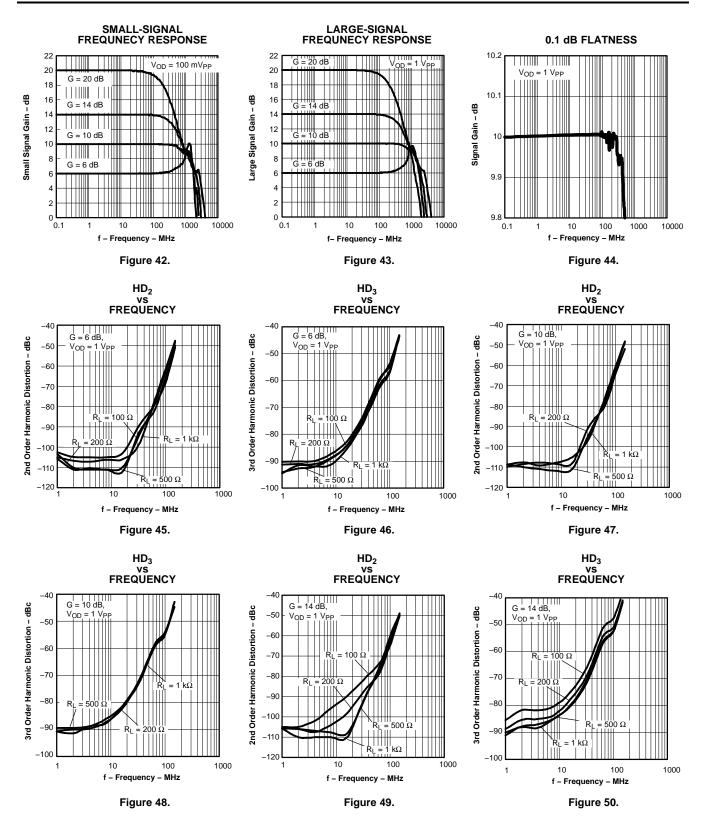


## TYPICAL AC PERFORMANCE: $V_{S+} - V_{S-} = 3 \text{ V}$

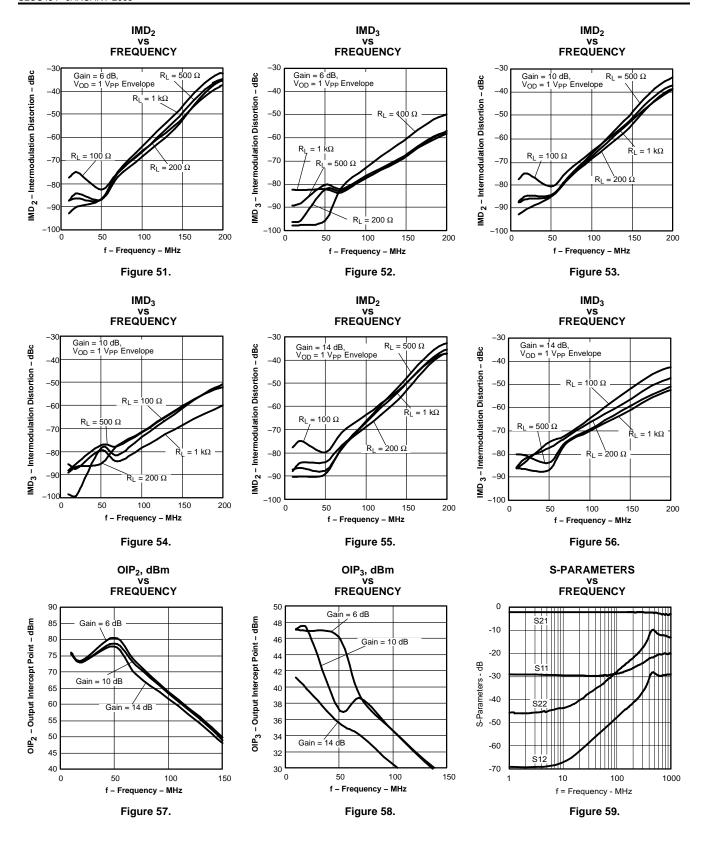
Test conditions unless otherwise noted:  $V_{S+}$  = +1.5 V,  $V_{S-}$  = -1.5V, CM = open,  $V_{OD}$  = 1 Vpp,  $R_F$  = 349  $\Omega$ ,  $R_L$  = 200  $\Omega$  Differential, G = 10 dB, Single-Ended Input, Input and Output Referenced to Midrail

Small-Signal Frequnecy Respon	se		Figure 42
Large Signal Frequnecy Respon	se		Figure 43
0.1 dB Flatness			Figure 44
	$HD_2$ , $G = 6$ dB, $V_{OD} = 1$ $V_{PP}$	vs Frequency	Figure 45
	$HD_3$ , $G = 6$ dB, $V_{OD} = 1$ $V_{PP}$	vs Frequency	Figure 46
Harmonic	$HD_2$ , G = 10 dB, $V_{OD}$ = 1 $V_{PP}$	vs Frequency	Figure 47
Distortion	$HD_3$ , $G = 10 dB$ , $V_{OD} = 1 V_{PP}$	vs Frequency	Figure 48
	$HD_2$ , G = 14 dB, $V_{OD}$ = 1 $V_{PP}$	vs Frequency	Figure 49
	$HD_3$ , $G = 14 dB$ , $V_{OD} = 1 V_{PP}$	vs Frequency	Figure 50
	$IMD_2$ , G = 6 dB, $V_{OD}$ = 1 $V_{PP}$	vs Frequency	Figure 51
	$IMD_3$ , G = 6 dB, $V_{OD}$ = 1 $V_{PP}$	vs Frequency	Figure 52
Intermodulation	$IMD_2$ , $G = 10 dB$ , $V_{OD} = 1 V_{PP}$	vs Frequency	Figure 53
Distortion	$IMD_3$ , G = 10 dB, $V_{OD}$ = 1 $V_{PP}$	vs Frequency	Figure 54
	$IMD_2$ , G = 14 dB, $V_{OD}$ = 1 $V_{PP}$	vs Frequency	Figure 55
	$IMD_3$ , G = 14 dB, $V_{OD}$ = 1 $V_{PP}$	vs Frequency	Figure 56
Ouput Intercept Point	OIP <sub>2</sub>	vs Frequency	Figure 57
Ouput intercept Foint	OIP <sub>3</sub>	vs Frequency	Figure 58
S-Parameters		vs Frequency	Figure 59
Slew Rate		vs Output Voltage	Figure 60
Transient Response			Figure 61
Settling Time			Figure 62
Output Voltage Swing		vs Load Resistance	Figure 63
Rejection Ratio		vs Frequency	Figure 64
Overdrive Recovery			Figure 65
Output Impedance		vs Frequency	Figure 66
Turn-Off Time			Figure 67
Turn-On Time			Figure 68
Ouput Balance Error		vs Frequency	Figure 69
Noise Figure		vs Frequency	Figure 70
CM Small-Signal Frequency Response			Figure 71
CM Input Impedance	·	vs Frequency	Figure 72
Differential Output Offset Voltage	e	vs CM Input Voltage	Figure 73
Output Common-Mode Offset		vs CM Input Voltage	Figure 74

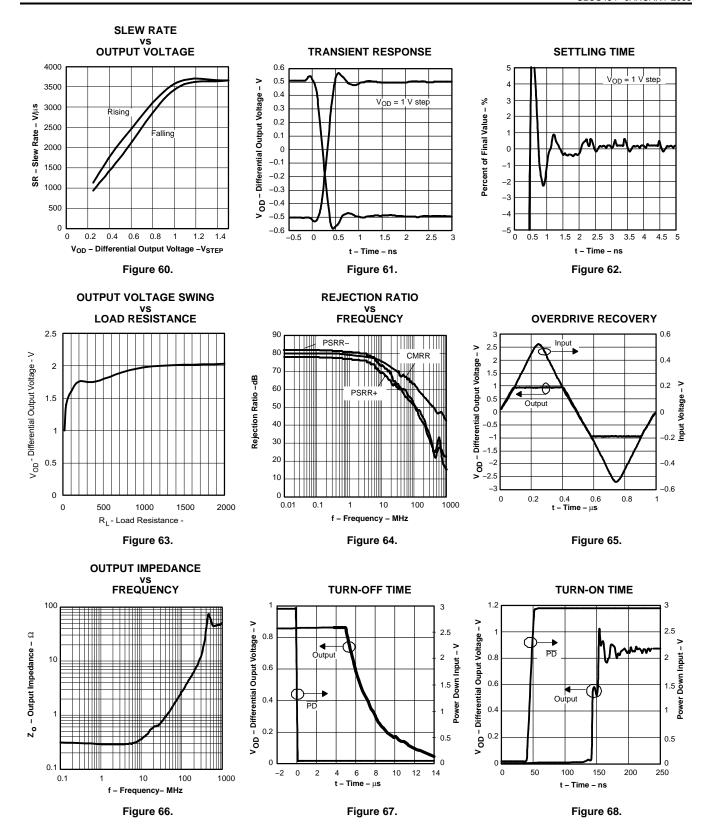




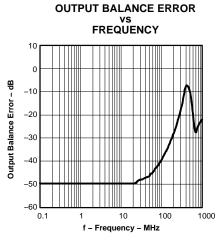


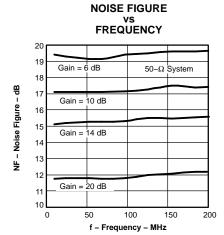












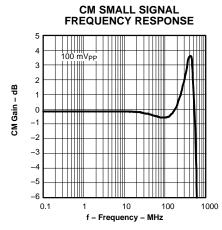


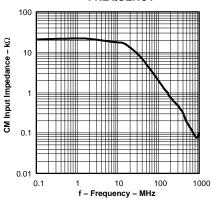
Figure 69.

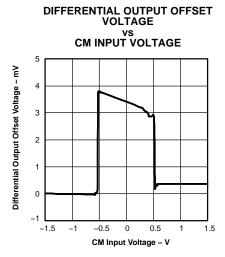
Figure 70.

Figure 71.

**OUTPUT COMMON-MODE OFFSET** 







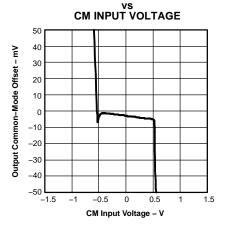


Figure 72.

Figure 73.

Figure 74.



#### **TEST CIRCUITS**

The THS4509 is tested with the following test circuits built on the EVM. For simplicity, power supply decoupling is not shown – see layout in the applications section for recommendations. Depending on the test conditions, component values are changed per the following tables, or as otherwise noted. The signal generators used are ac coupled 50- $\Omega$  sources and a 0.22- $\mu$ F capacitor and a 49.9- $\Omega$  resistor to ground are inserted across  $R_{\rm IT}$  on the alternate input to balance the circuit. A split power supply is used to ease the interface to common test equipment, but the amplifier can be operated single-supply as described in the applications section with no impact on performance.

**Table 1. Gain Component Values** 

GAIN	R <sub>F</sub>	R <sub>G</sub>	R <sub>IT</sub>
6 dB	348 Ω	165 Ω	61.9 Ω
10 dB	348 Ω	100 Ω	69.8 Ω
14 dB	348 Ω	56.2 Ω	88.7 Ω
20 dB	348 Ω	16.5 Ω	287 Ω

Note the gain setting includes 50- $\Omega$  source impedance. Components are chosen to achieve gain and 50- $\Omega$  input termination.

**Table 2. Load Component Values** 

R <sub>L</sub>	R <sub>O</sub>	R <sub>OT</sub>	Atten.
100 Ω	25 Ω	open	6 dB
200 Ω	86.6 Ω	69.8 Ω	16.8 dB
499 Ω	237 Ω	56.2 Ω	25.5 dB
1k Ω	487 Ω	52.3 Ω	31.8 dB

Note the total load includes 50- $\Omega$  termination by the test equipment. Components are chosen to achieve load and 50- $\Omega$  line termination through a 1:1 transformer.

Due to the voltage divider on the output formed by the load component values, the amplifier's output is attenuated. The column *Atten* in Table 2 shows the attenuation expected from the resistor divider. When using a transformer at the output as shown in Figure 76, the signal will see slightly more loss, and these numbers will be approximate.

#### **Frequency Response**

The circuit shown in Figure 75 is used to measure the frequency response of the circuit.

A network analyzer is used as the signal source and as the measurement device. The output impedance of the network analyzer is 50  $\Omega.$   $R_{\text{IT}}$  and  $R_{\text{G}}$  are chosen to impedance match to 50  $\Omega,$  and to maintain the proper gain. To balance the amplifier, a 0.22- $\mu\text{F}$  capacitor and 49.9- $\Omega$  resistor to ground are inserted across  $R_{\text{IT}}$  on the alternate input.

The output is probed using a high-impedance differential probe across the  $100-\Omega$  resistor. The gain is referred to the amplifier output by adding back the 6-dB loss due to the voltage divider on the output.

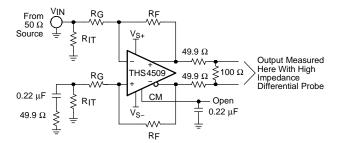


Figure 75. Frequency Response Test Circuit

#### **Distortion and 1dB Compression**

The circuit shown in Figure 76 is used to measure harmonic distortion, intermodulation distortion, and 1-db compression point of the amplifier.

A signal generator is used as the signal source and the output is measured with a spectrum analyzer. The output impedance of the signal generator is 50  $\Omega.$   $R_{\text{IT}}$  and  $R_{\text{G}}$  are chosen to impedance-match to 50  $\Omega,$  and to maintain the proper gain. To balance the amplifier, a 0.22- $\mu\text{F}$  capacitor and 49.9- $\Omega$  resistor to ground are inserted across  $R_{\text{IT}}$  on the alternate input.

A low-pass filter is inserted in series with the input to reduce harmonics generated at the signal source. The level of the fundamental is measured, then a high-pass filter is inserted at the output to reduce the fundamental so that it does not generate distortion in the input of the spectrum analyzer.

The transformer used in the output to convert the signal from differential to single ended is an ADT1-1WT. It limits the frequency response of the circuit so that measurements cannot be made below approximately 1MHz.

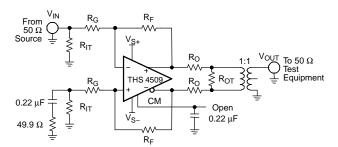


Figure 76. Distortion Test Circuit

The 1-dB compression point is measured with a spectrum analyzer with  $50-\Omega$  double termination or



 $100-\Omega$  termination as shown in Table 2. The input power is increased until the output is 1 dB lower than expected. The number reported in the table data is the power delivered to the spectrum analyzer input. Add 3 dB to refer to the amplifier output.

# S-Parameter, Slew Rate, Transient Response, Settling Time, Output Impedance, Overdrive, Output Voltage, and Turn-On/Off Time

The circuit shown in Figure 77 is used to measure s-parameters, slew rate, transient response, settling time, output impedance, overdrive recovery, output voltage swing, and turn-on/turn-off times of the amplifier. For output impedance, the signal is injected at  $V_{\text{OUT}}$  with  $V_{\text{IN}}$  left open and the drop across the 49.9  $\Omega$  resistor is used to calculate the impedance seen looking into the amplifier's output.

Because  $S_{21}$  is measured single-ended at the load with  $50-\Omega$  double termination, add 12 dB to refer to the amplifier's output as a differential signal.

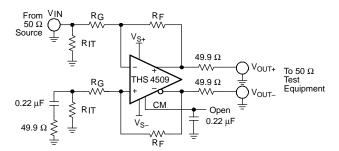


Figure 77. S-Parameter, SR, Transient Response, Settling Time, Z<sub>0</sub>, Overdrive Recovery, V<sub>OUT</sub> Swing, and Turn-on/off Test Circuit

#### **CM** Input

The circuit shown in Figure 78 is used to measure the frequency response and input impedance of the CM input. Frequency response is measured single-ended

at  $V_{OUT+}$  or  $V_{OUT-}$  with the input injected at  $V_{IN}$ ,  $R_{CM}$  = 0  $\Omega$  and  $R_{CMT}$  = 49.9  $\Omega$ . The input impedance is measured with  $R_{CM}$  = 49.9  $\Omega$  with  $R_{CMT}$  = open, and calculated by measuring the voltage drop across  $R_{CM}$  to determine the input current.

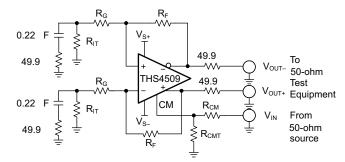


Figure 78. CM Input Test Circuit

#### **CMRR and PSRR**

The circuit shown in Figure 79 is used to measure the CMRR and PSRR of  $V_{S+}$  and  $V_{S-}$ . The input is switched appropriately to match the test being performed.

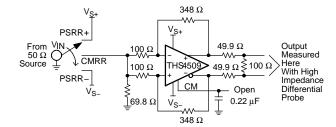


Figure 79. CMRR and PSRR Test Circuit



#### **APPLICATION INFORMATION**

#### **APPLICATIONS**

The following circuits show application information for the THS4509. For simplicity, power supply decoupling capacitors are not shown in these diagrams. Please see the Subsection 1 section for recommendations. For more detail on the use and operation of fully differential op amps refer to application report *Fully-Differential Amplifiers* (SLOA054).

#### **Differential Input to Differential Output Amplifier**

The THS4509 is a fully differential op amp, and can be used to amplify differential input signals to differential output signals. A basic block diagram of the circuit is shown in Figure 80 (CM input not shown). The gain of the circuit is set by  $R_{\rm F}$  divided by  $R_{\rm G}$ .

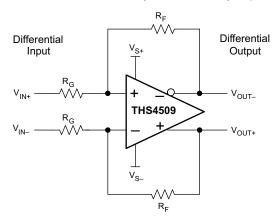


Figure 80. Differential Input to Differential Ouput Amplifier

Depending on the source and load, input and output termination can be accomplished by adding  $R_{\text{IT}}$  and  $R_{\text{O}}.$ 

# Single-Ended Input to Differential Output Amplifier

The THS4509 can be used to amplify and convert single-ended input signals to differential output signals. A basic block diagram of the circuit is shown in Figure 81 (CM input not shown). The gain of the circuit is again set by  $R_{\rm F}$  divided by  $R_{\rm G}$ .

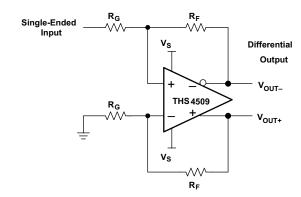


Figure 81. Single-Ended Input to Differential Output Amplifier

#### Input Common-Mode Voltage Range

The input common-model voltage of a fully differential op amp is the voltage at the '+' and '-' input pins of the op amp.

It is important to not violate the input common-mode voltage range ( $V_{ICR}$ ) of the op amp. Assuming the op amp is in linear operation the voltage across the input pins is only a few millivolts at most. So finding the voltage at one input pin will determine the input common-mode voltage of the op amp.

Treating the negative input as a summing node, the voltage is given by Equation 1:

$$V_{IC} \quad V_{OUT} \quad \frac{R_G}{R_G \quad R_F} \quad V_{IN} \quad \frac{R_F}{R_G \quad R_F} \tag{1} \label{eq:equation_potential}$$

To determine the  $V_{\text{ICR}}$  of the op amp, the voltage at the negative input is evaluated at the extremes of  $V_{\text{Ol\,IT+}}.$ 

As the gain of the op amp increases, the input common-mode voltage becomes closer and closer to the input common-mode voltage of the source.

#### **Setting the Output Common-Mode Voltage**

The output common-mode voltage is set by the voltage at the CM pin(s). The internal common-mode control circuit maintains the output common-mode voltage within 3-mV offset (typ) from the set voltage, when set within 0.5 V of mid-supply, with less than 4mV differential offset voltage. If left unconnected, the common-mode set point is set to mid-supply by internal circuitry, which may be over-driven from an external source. Figure 82 is representative of the CM input. The internal CM circuit has about 700 MHz of -3-dB bandwidth, which is required for best per-



formance, but it is intended to be a DC bias input pin. Bypass capacitors are recommended on this pin to reduce noise at the output. The external current required to overdrive the internal resistor divider is given by Equation 2:

$$I_{EXT} = \frac{2V_{CM} - V_{S} - V_{S}}{50 \text{ k}}$$
 (2)

where V<sub>CM</sub> is the voltage applied to the CM pin.

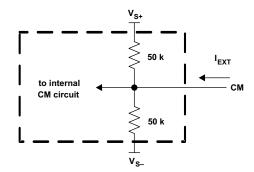


Figure 82. CM Input Circuit

#### Single-Supply Operation (3V to 5V)

To facilitate testing with common lab equipment, the THS4509 EVM allows split-supply operation, and the characterization data presented in this data sheet was taken with split-supply power inputs. The device can easily be used with a single-supply power input without degrading the performance. Figure 83, Figure 84, and Figure 85 show DC and AC-coupled single-supply circuits with single-ended inputs. These configurations all allow the input and output common-mode voltage to be set to mid-supply allowing for optimum performance. The information presented here can also be applied to differential input sources.

In Figure 83, the source is referenced to the same voltage as the CM pin ( $V_{CM}$ ).  $V_{CM}$  is set by the internal circuit to mid-supply.  $R_T$  along with the input impedance of the amplifier circuit provides input termination, which is also referenced to  $V_{CM}$ .

Note  $R_S$  and  $R_T$  are added to the alternate input from the signal input to balance the amplifier. Alternately, one resistor can be used equal to the combined value  $R_G + R_S || R_T$  on this input. This is also true of the circuits shown in Figure 84 and Figure 85.

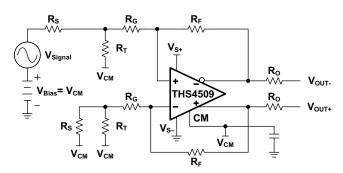


Figure 83. THS4509 DC Coupled Single-Supply with Input Biased to V<sub>CM</sub>

In Figure 84 the source is referenced to ground and so is the input termination resistor.  $R_{PU}$  is added to the circuit to avoid violating the  $V_{ICR}$  of the op amp. The proper value of resistor to add can be calculated from Equation 3:

$$R_{PU} = \frac{V_{IC} - V_{S}}{V_{CM} \frac{1}{R_{F}} - V_{IC} \frac{1}{R_{IN}} - \frac{1}{R_{F}}}$$
(3)

 $V_{IC}$  is the desire input common-mode voltage,  $V_{CM}$  = CM, and  $R_{IN}$  =  $R_G$ +  $R_S$ || $R_T$ . To set to mid-supply, make the value of  $R_{PU}$  =  $R_G$ +  $R_S$ || $R_T$ .

Table 3 is a modification of Table 1 to add the proper values with  $R_{PU}$  assuming a 50  $\Omega$  source impedance and setting the input and output common-mode voltage to mid-supply.

There are two drawbacks to this configuration. One is it requires additional current from the power supply. Using the values shown for a gain of 10 dB requires 37 mA more current with 5 V supply, and 22 mA more current with 3 V supply.

The other drawback is this configuration also increases the noise gain of the circuit. In the 10 dB gain case, noise gain increases by a factor of 1.5.

**Table 3. RPU Values for Various Gains** 

Gain	R <sub>F</sub>	R <sub>G</sub>	R <sub>IT</sub>	R <sub>PU</sub>
6 dB	348 Ω	169 Ω	64.9 Ω	200 Ω
10 dB	348 Ω	102 Ω	78.7 Ω	133 Ω
14 dB	348 Ω	61.9 Ω	115 Ω	97.6 Ω
20 dB	348 Ω	40.2 Ω	221 Ω	80.6 Ω



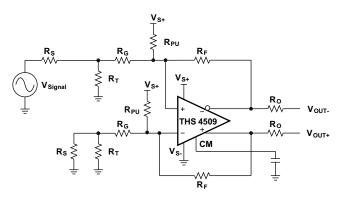


Figure 84. THS4509 DC Coupled Single-Supply with R<sub>PII</sub> Used to Set V<sub>IC</sub>

Figure 85 shows AC coupling to the source. Using capacitors in series with the termination resistors allows the amplifier to self-bias both input and output to mid-supply.

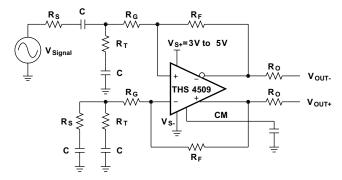


Figure 85. THS4509 AC Coupled Single-Supply

#### THS4509 + ADS5500 Combined Performance

The THS4509 is designed to be a high performance drive amplifier for high performance data converters like the ADS5500 14-bit 125-MSPS ADC. Figure 86 shows a circuit combining the two devices, and Figure 87 shows the combined SNR and SFDR performance versus frequency with -1 dBFS input signal level sampling at 125 MSPS. The THS4509 amplifier circuit provides 10 dB of gain, converts the single-ended input to differential, and sets the proper input common-mode voltage to the ADS5500. The 100- $\Omega$  resistors and 2.7-pF capacitor between the THS4509 outputs and ADS5500 inputs along with the input capacitance of the ADS5500 limit the bandwidth of the signal to 115 MHz (-3 dB). For testing, a signal generator is used for the signal source. The generator is an AC-coupled 50- $\Omega$  source. A band-pass filter

is inserted in series with the input to reduce harmonics and noise from the signal source. Input termination is accomplished via the  $69.8-\Omega$  resistor and 0.22-µF capacitor to ground in conjunction with the input impedance of the amplifier circuit. A 0.22-µF capacitor and  $49.9-\Omega$  resistor is inserted to ground across the 69.8-Ω resistor and 0.22-μF capacitor on the alternate input to balance the circuit. Gain is a function of the source impedance, termination, and 348- $\Omega$  feedback resistor. Refer to Table 3 for component values to set proper  $50-\Omega$  termination for other common gains. A split power supply of +4V and -1V is used to set the input and output common-mode voltages to approximately mid-supply while setting the input common-mode of the ADS5500 to the recommended +1.55V. This maintains maximum headroom on the internal transistors of the THS4509 to insure optimum performance.

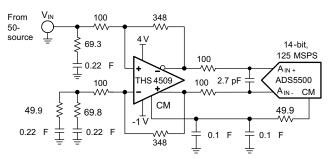


Figure 86. THS4509 + ADS5500 Circuit

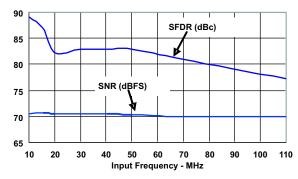


Figure 87. THS4509 + ADS5500 SFDR and SNR Performance versus Frequency

Figure 88 shows the 2-tone FFT of the THS4509 + ADS5500 circuit with 65 MHz and 70 MHz input frequencies. The SFDR is 90 dBc.



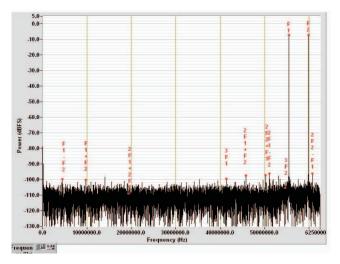


Figure 88. THS4509 + ADS5500 2-Tone FFT with 65 MHz and 70 MHz Input

#### THS4509 + ADS5424 Combined Performance

Figure 89 shows the THS4509 driving the ADS5424 ADC, and Figure 90 shows their combined SNR and SFDR performance versus frequency with -1 dBFS input signal level and sampling at 80 MSPS.

As before, the THS4509 amplifier provides 10 dB of gain, converts the single-ended input to differential, and sets the proper input common-mode voltage to the ADS5424. Input termination and circuit testing is the same as described above for the THS4509 + ADS5500 circuit.

The  $225-\Omega$  resistors and 2.7-pF capacitor between the THS4509 outputs and ADS5424 inputs (along with the input capacitance of the ADC) limit the bandwidth of the signal to about 100MHz (-3dB).

Since the ADS5424s recommended input common-mode voltage is 2.4 V, the THS4509 is operated from a single power supply input with  $V_{S+}=5$  V and  $V_{S-}=0$  V (ground).

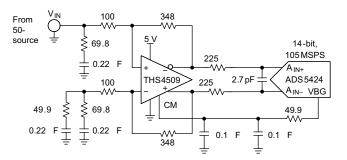


Figure 89. THS4509 + ADS5424 Circuit

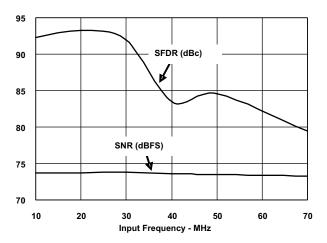


Figure 90. THS4509 + ADS5424 SFDR and SNR Performance vs Frequency



#### **Layout Recommendations**

It is recommended to follow the layout of the external components near the amplifier, ground plane construction, and power routing of the EVM as closely as possible. General guidelines are:

- 1. Signal routing should be direct and as short as possible into and out of the opamp circuit.
- 2. The feedback path should be short and direct avoiding vias.
- Ground or power planes should be removed from directly under the amplifier's input and output pins.
- 4. An output resistor is recommended on each output, as near to the output pin as possible.
- Two 10-μF and two 0.1-μF power-supply decoupling capacitors should be placed as near to the power-supply pins as possible.
- 6. Two 0.1-µF capacitors should be placed between the CM input pins and ground. This limits noise coupled into the pins. One each should be placed to ground near pin 4 and pin 9.
- It is recommended to split the ground pane on layer 2 (L2) as shown below and to use a solid ground on layer 3 (L3). A single-point connection should be used between each split section on L2 and L3.
- 8. A single-point connection to ground on L2 is recommended for the input termination resistors R1 and R2. This should be applied to the input gain resistors if termination is not used.
- 9. The THS4509 recommended PCB footprint is shown in Figure 91.

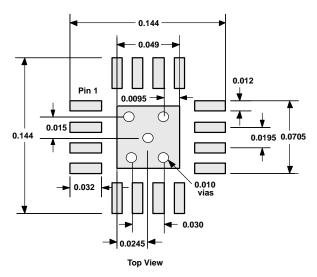


Figure 91. QFN Etch and Via Pattern



#### **THS4509 EVM**

Figure 92 is the THS4509 EVAL1 EVM schematic, layers 1 through 4 of the PCB are shown Figure 93, and Table 4 is the bill of material for the EVM as supplied from TI.

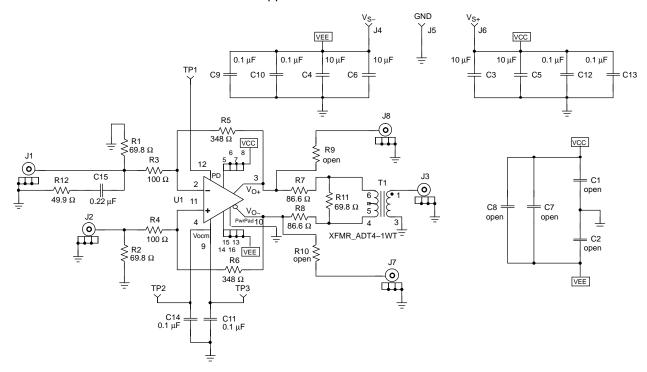


Figure 92. THS4509 EVAL1 EVM Schematic

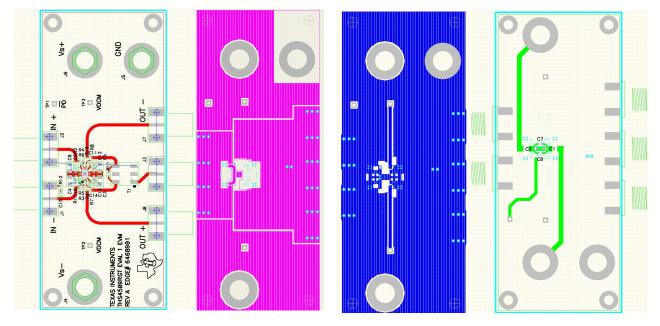


Figure 93. THS4509 EVAL1 EVM Layer 1 through 4



## Table 4. THS4509 EVAL1 EVM Bill of Materials

ITEM	DESCRIPTION	SMD SIZE	REFERENCE DESIGNATOR	PCB QTY	MANUFACTURER'S PART NUMBER
1	CAP, 10.0 µF, Ceramic, X5R, 6.3V	0805	C3, C4, C5, C6	4	(AVX) 08056D106KAT2A
2	CAP, 0.1 µF, Ceramic, X5R, 10V	0402	C9, C10, C11, C12, C13, C14	6	(AVX) 0402ZD104KAT2A
3	CAP, 0.22 µF, Ceramic, X5R, 6.3V	0402	C15	1	(AVX) 04026D224KAT2A
4	OPEN	0402	C1, C2, C7, C8	4	
5	OPEN	0402	R9, R10	2	
6	Resistor, 49.9 Ω, 1/16W, 1%	0402	R12	1	(KOA) RK73H1ETTP49R9F
8	Resistor, 69.8 Ω, 1/16W, 1%	0402	R1, R2, R11	3	(KOA) RK73H1ETTP69R8F
9	Resistor, 86.6 Ω, 1/16W, 1%	0402	R7, R8	2	(KOA) RK73H1ETTP86R6F
10	Resistor, 100 Ω, 1/16W, 1%	0402	R3, R4	2	(KOA) RK73H1ETTP1000F
11	Resistor, 348 Ω, 1/16W, 1%	0402	R5, R6	2	(KOA) RK73H1ETTP3480F
12	Transformer, RF		T1	1	(MINI-CIRCUITS) ADT1-1WT
13	Jack, banana receptance, 0.25" diameter hole		J4, J5, J6	3	(HH SMITH) 101
14	OPEN		J1, J7, J8	3	
15	Connector, edge, SMA PCB Jack		J2, J3	2	(JOHNSON) 142-0701-801
16	Test point, Red		TP1, TP2, TP3	3	(KEYSTONE) 5000
17	IC, THS4509		U1	1	(TI) THS4509RGT
18	Standoff, 4-40 HEX, 0.625" length			4	(KEYSTONE) 1808
19	SCREW, PHILLIPS, 4-40, 0.250"			4	SHR-0440-016-SN
20	Printed circuit board			1	(TI) EDGE# 6468901



### THERMAL PAD MECHANICAL DATA

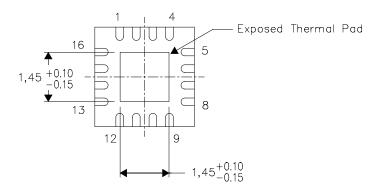
RGT (S-PQFP-N16)

#### THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB), the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to a ground plane or special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No—Lead (QFN) package and its advantages, refer to Application Report, Quad Flatpack No—Lead Logic Packages, Texas Instruments Literature No. SCBA017. This document is available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.



Bottom View

NOTE: All linear dimensions are in millimeters

Exposed Thermal Pad Dimensions

4206349-2/B 11/04



#### PACKAGE OPTION ADDENDUM

25-Jan-2005

#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins F	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
THS4509RGTR	ACTIVE	QFN	RGT	16	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
THS4509RGTT	ACTIVE	QFN	RGT	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in

a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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